


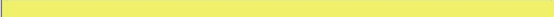









Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0.012mm	3.5
4		Top Layer	Copper	0.035mm	
5		Dielectric 1	FR-4	0.200mm	4.6
6		Layer 2	Copper	0.018mm	
7		Dielectric 2	FR-4	1.065mm	4.6
8		Layer 3	Copper	0.018mm	
9		Dielectric 3	FR-4	0.200mm	4.6
10		Bottom Layer	Copper	0.035mm	
11		Bottom Solder	Solder Resist	0.012mm	3.5
12		Bottom Overlay			
13		Bottom Paste			
	Height : 1.595mm				